

1200V 16mohm Silicon Carbide Power MOSFET

AKCK2M016WAMH-39A

Features:

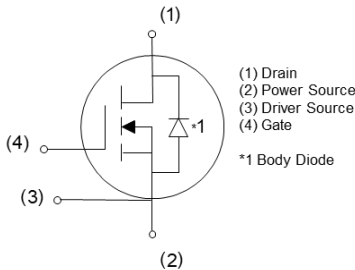
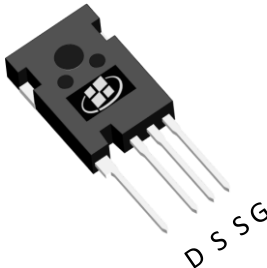
- Low on-resistance
- Fast switching speed with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{RR})
- Halogen-free, RoHS compliant ^(Note 1)

Applications:

- Motor drives
- DC/DC converters
- Switched mode power supplies
- Solar inverters
- Boost inverters

Key Performance Parameters:

Parameter	Value	Unit
V_{DS}	1200	V
$R_{DS(on)}$, TYP @ $V_{GS} = 18\text{ V}$	16	m Ω
I_D	125	A
P_D	600	W



Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKCK2M016WAMH-39A	TO-247-4L	CK2M016WAMH	Tube	See the detail package information

Notes:

1. Contact ALKAIDSEMI sales for detail information

Maximum Ratings (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Value	Units
V _{DS}	Drain-Source Voltage	1200	V
I _D	Drain Current - Continuous (T _C = 25°C) ^(Note 1)	125	A
	Drain Current - Continuous (T _C = 100°C) ^(Note 1)	90	A
I _{DM}	Drain Current - Pulsed ^(Note 2)	200	A
V _{GS}	Gate-Source Voltage (dynamic)	-10/+22	V
V _{GS}	Gate-Source Voltage (static)	-6/+18	V
P _D	Power Dissipation (T _C = 25°C)	600	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +175	°C

Thermal Characteristics

Symbol	Parameter	Value	Units
R _{θJC}	Thermal Resistance, Junction-to-Case, Steady-State	0.25	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient, Steady-State	36	°C/W

Notes:

1. The max drain current limited by maximum junction temperature
2. Repetitive Rating: Pulse width limited by maximum junction temperature

Electrical Characteristics (T _J = 25°C unless otherwise noted)						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 100 μA	1200			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 1200 V, V _{GS} = 0 V		5	50	μA
I _{GSS}	Gate Leakage Current	V _{GS} = + 18 V, V _{DS} = 0 V			100	nA
		V _{GS} = - 6 V, V _{DS} = 0 V			100	nA
V _{GS(TH)}	Gate Threshold voltage	V _{DS} = V _{GS} , I _D = 23 mA	2.7	3.2	3.6	V
		V _{DS} = V _{GS} , I _D = 23 mA, T _J = 175 °C		2.2		V
R _{DS(ON)}	Drain-Source on-state resistance	V _{GS} = 18 V, I _D = 75 A	11	16	20	mΩ
		V _{GS} = 18 V, I _D = 75 A, T _J = 175 °C		27		mΩ
G _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 75 A		25		S
		V _{DS} = 20 V, I _D = 75 A, T _J = 175 °C		14		S
Dynamic Characteristics						
C _{ISS}	Input Capacitance	V _{DS} = 800 V, V _{GS} = 0 V, F = 100 kHz, V _{AC} = 25 mV		5220		pF
C _{OSS}	Output Capacitance			247		pF
C _{RSS}	Reverse Transfer Capacitance			33		pF
E _{OSS}	C _{OSS} Stored Energy			100		μJ
R _G	Gate Resistance	F = 1 MHz, V _{AC} = 25 mV		1.7		Ω
Q _{GS}	Gate-Source Charge	V _{DS} = 800 V , I _D = 75 A, V _{GS} = -5/+18 V		70		nC
Q _{GD}	Gate-Drain Charge			152		nC
Q _G	Total Gate Charge			295		nC

Switching Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$T_{D(ON)}$	Turn On Delay Time	$V_{DD} = 800\text{ V}$, $I_D = 75\text{ A}$, $V_{GS} = -5/+18\text{ V}$, $R_{G,EXT} = 10\text{ }\Omega$ $L = 99\text{ }\mu\text{H}$ Diode: Body Diode at $V_{GS} = -5\text{ V}$		103		ns
T_R	Rise Time			57		ns
$T_{D(OFF)}$	Turn Off Delay Time			133		ns
T_F	Fall Time			42		ns
E_{ON}	Turn On Energy			2495		μJ
E_{OFF}	Turn Off Energy			2057		μJ
$T_{D(ON)}$	Turn On Delay Time	$V_{DD} = 800\text{ V}$, $I_D = 75\text{ A}$, $V_{GS} = -5/+18\text{ V}$, $R_{G,EXT} = 10\text{ }\Omega$ $L = 99\text{ }\mu\text{H}$ Diode: Body Diode at $V_{GS} = -5\text{ V}$ $T_J = 175\text{ }^\circ\text{C}$		90		ns
T_R	Rise Time			45		ns
$T_{D(OFF)}$	Turn Off Delay Time			150		ns
T_F	Fall Time			43		ns
E_{ON}	Turn On Energy			2285		μJ
E_{OFF}	Turn Off Energy			2220		μJ

Drain-Source Diode Characteristics ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted)

I_S	Maximum Continuous Drain-Source Diode Forward Current			125	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current			200	A
V_{SD}	Diode Forward Voltage	$V_{GS} = -4\text{ V}$, $I_{SD} = 37.5\text{ A}$		5.2	V
		$V_{GS} = -4\text{ V}$, $I_{SD} = 37.5\text{ A}$, $T_J = 175\text{ }^\circ\text{C}$		4.7	V
I_{RM}	Peak Reverse Recovery Current	$V_{GS} = -4\text{ V}$, $I_{SD} = 75\text{ A}$, $V_R = 800\text{ V}$, $di/dt = 1400\text{ A}/\mu\text{s}$		26	A
T_{RR}	Reverse Recovery Time			34	ns
Q_{RR}	Reverse Recovery Charge			506	nC
I_{RM}	Peak Reverse Recovery Current	$V_{GS} = -4\text{ V}$, $I_{SD} = 75\text{ A}$, $V_R = 800\text{ V}$, $di/dt = 1400\text{ A}/\mu\text{s}$ $T_J = 175\text{ }^\circ\text{C}$		30	A
T_{RR}	Reverse Recovery Time			84	ns
Q_{RR}	Reverse Recovery Charge			1236	nC

Electrical Characteristics Diagrams

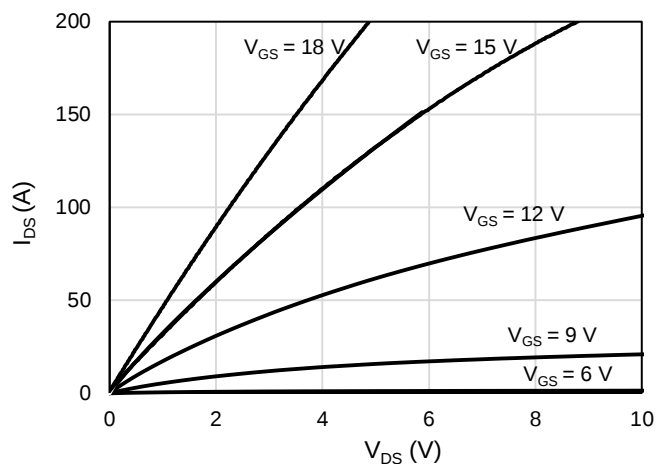
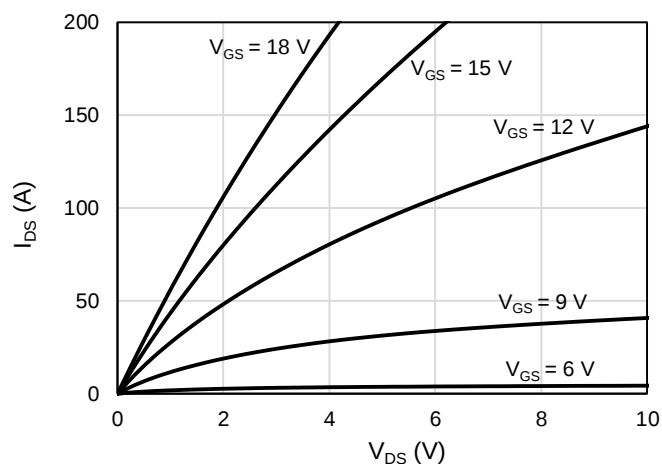
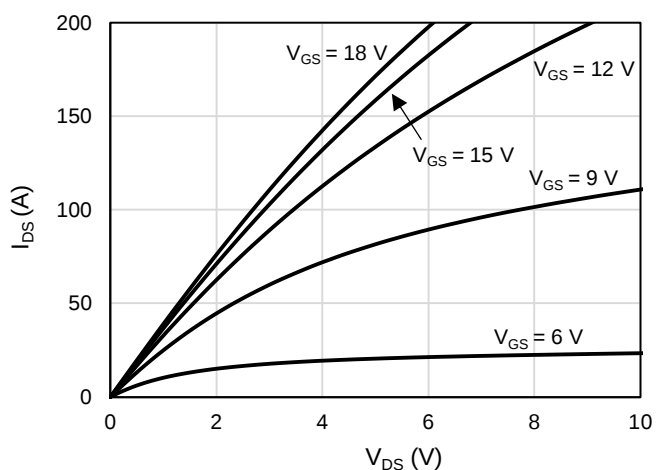
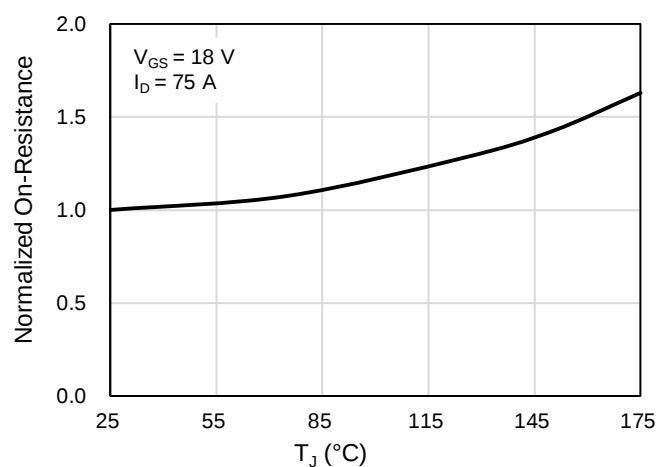
Figure 1: Output Characteristics $T_J = -40^{\circ}\text{C}$ Figure 2: Output Characteristics $T_J = 25^{\circ}\text{C}$ Figure 3: Output Characteristics $T_J = 175^{\circ}\text{C}$ 

Figure 4: Normalized On-Resistance vs. Temperature

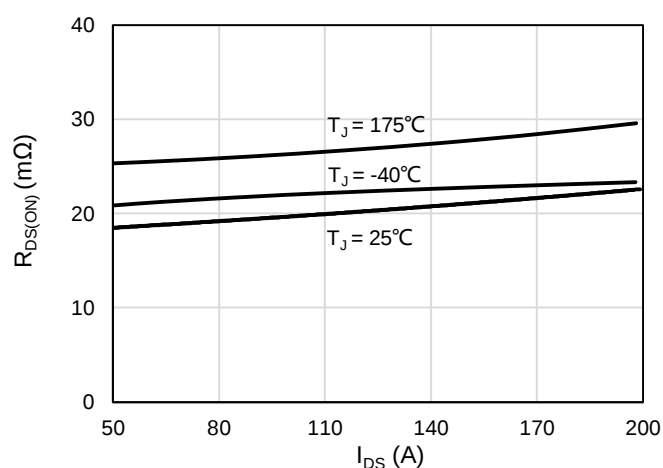


Figure 5: On-Resistance vs. Drain Current For Various Temperatures

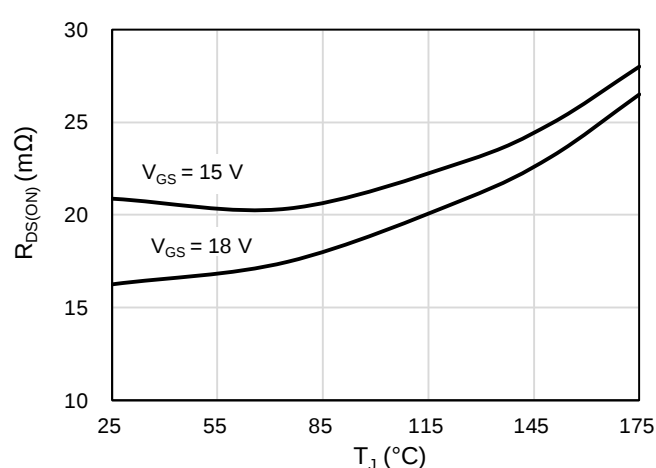
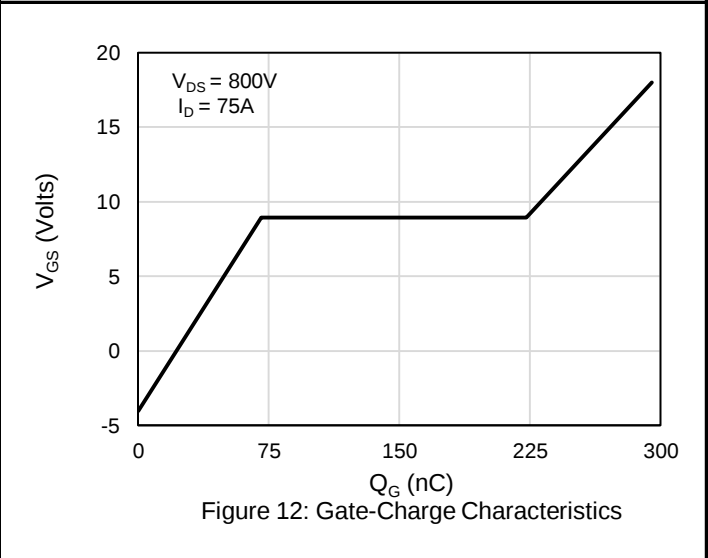
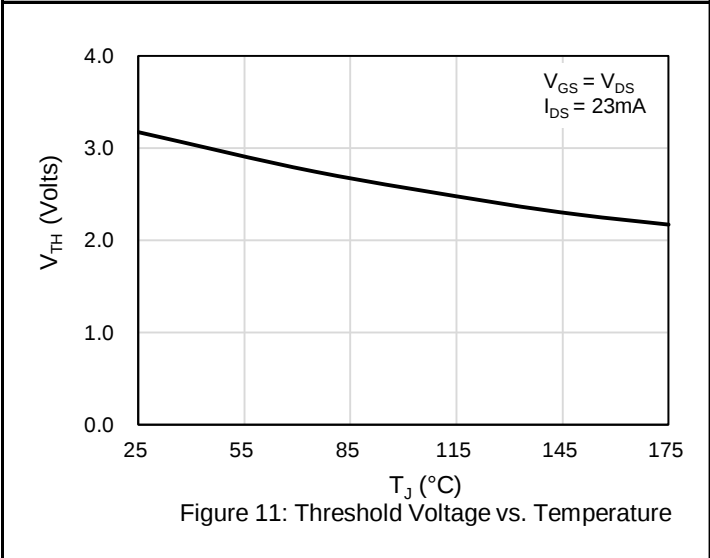
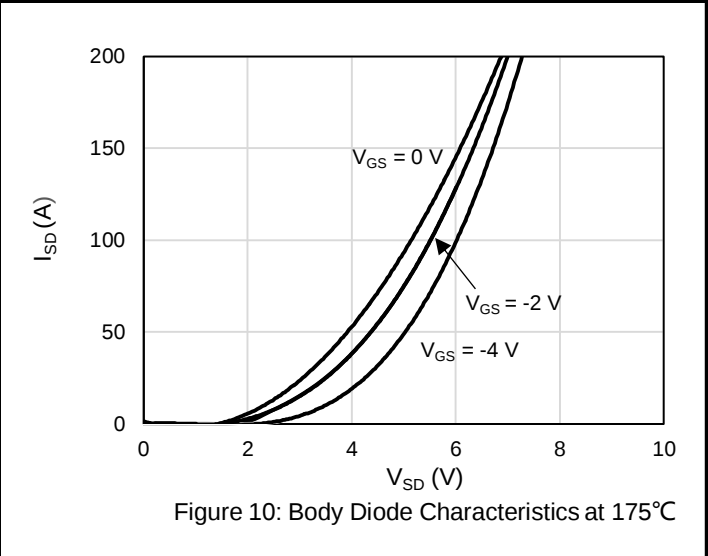
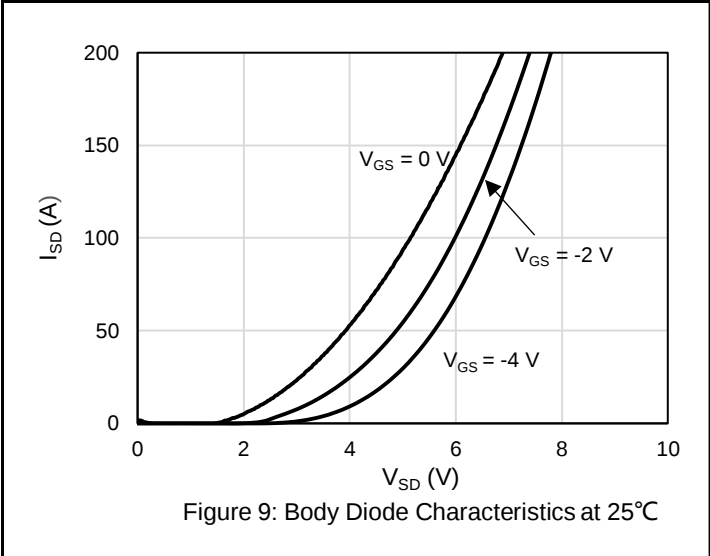
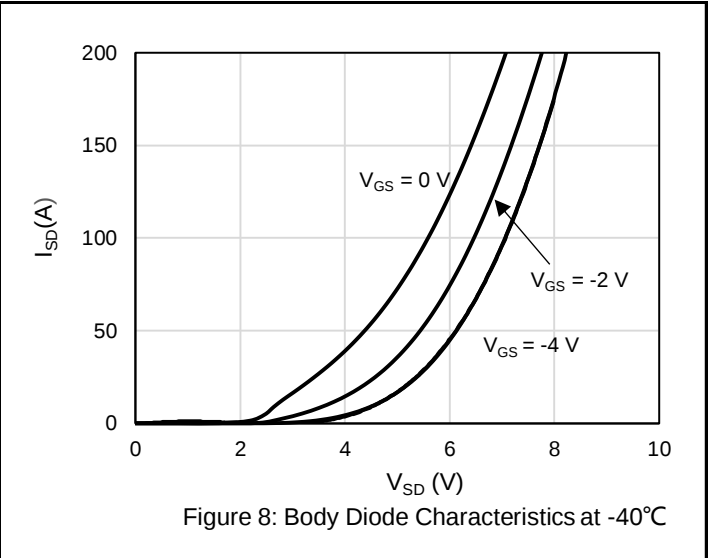
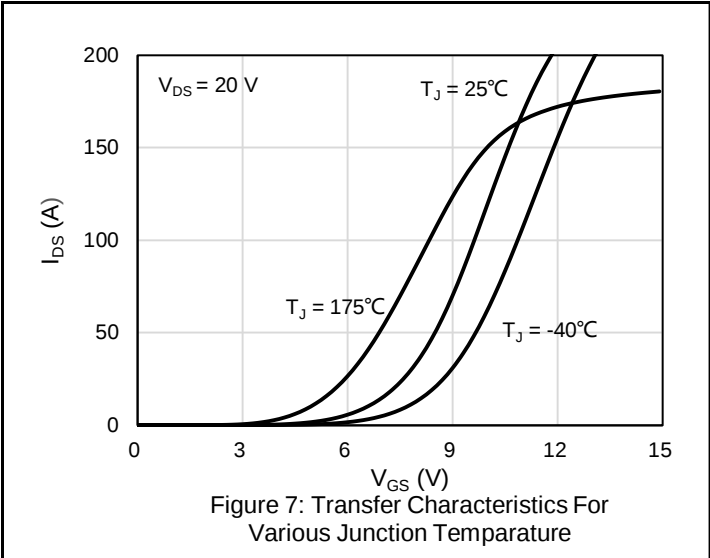
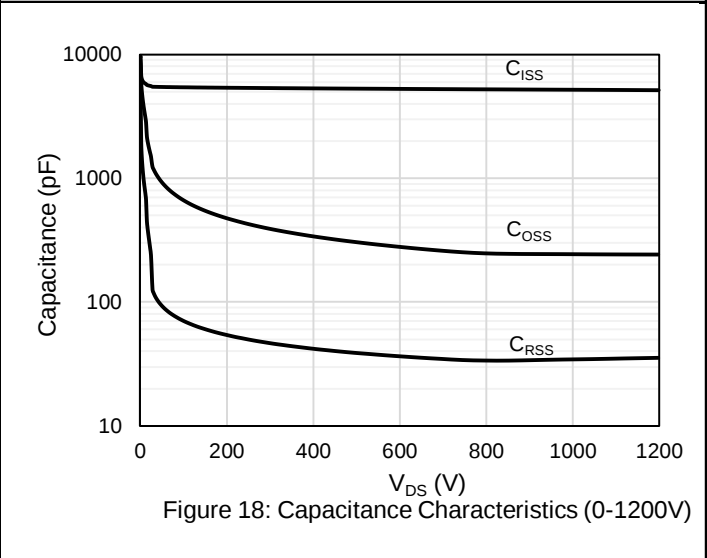
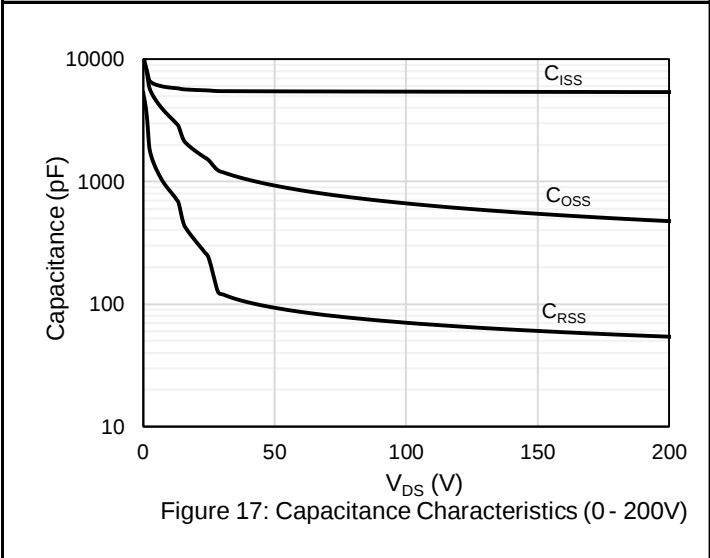
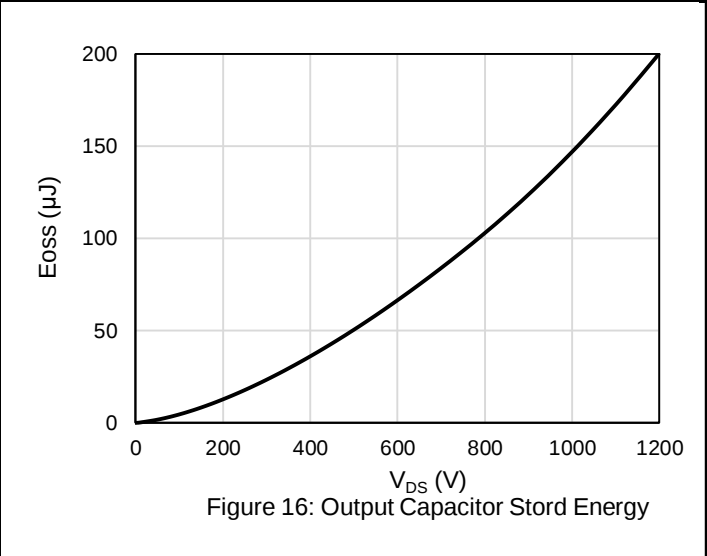
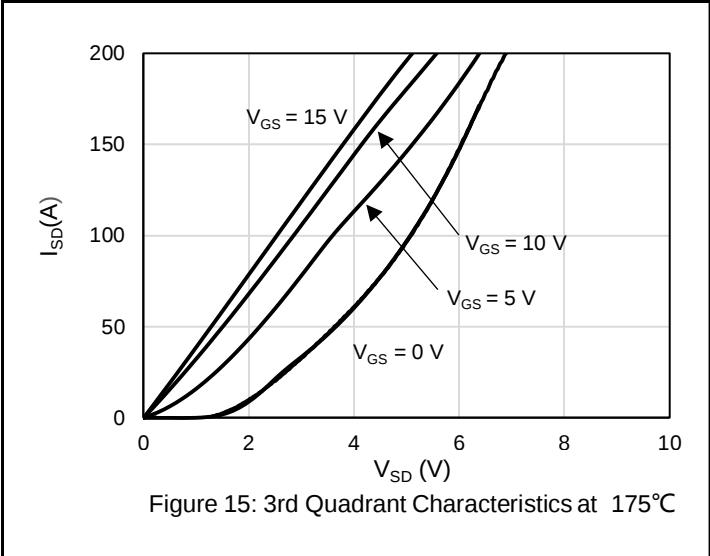
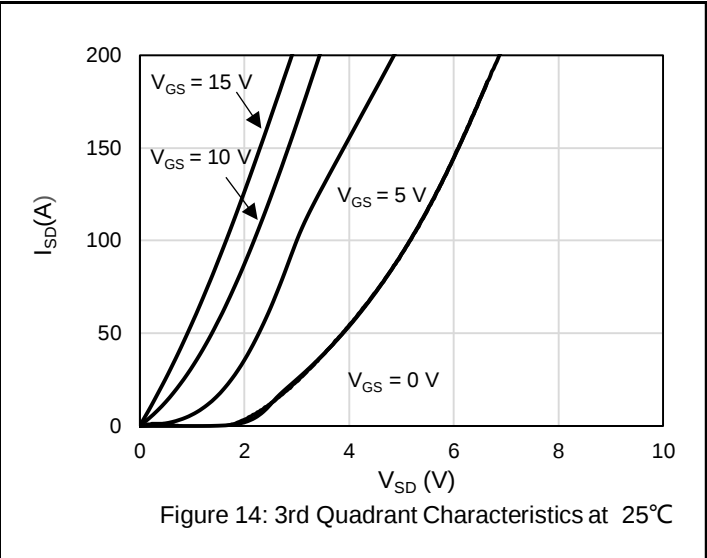
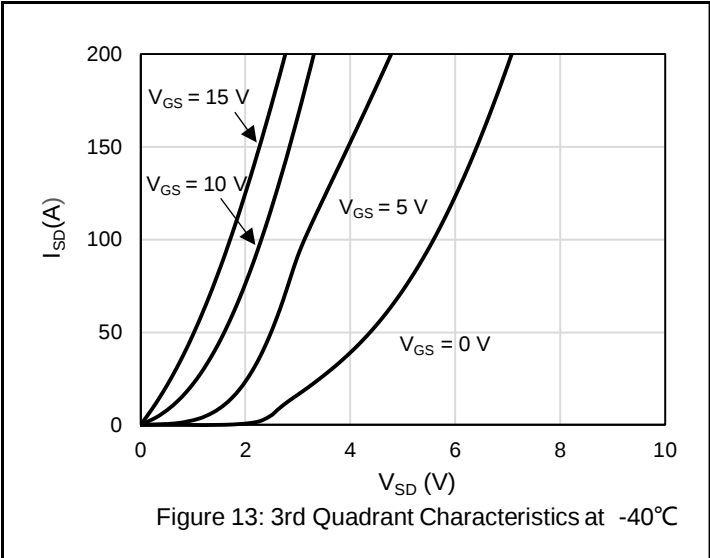


Figure 6: On-Resistance vs. Temperature For Various Gate Voltage





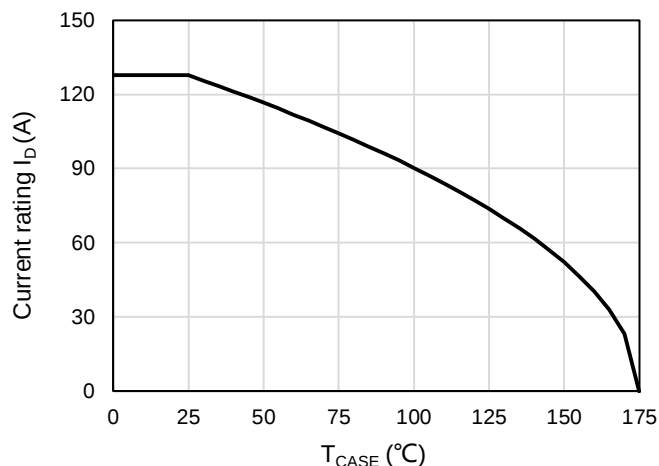


Figure 19: Current De-rating

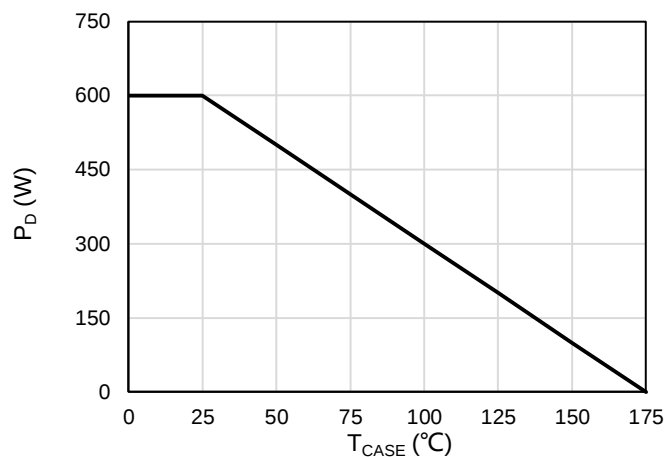


Figure 20: Maximum Power Dissipation Derating vs Case Temperature

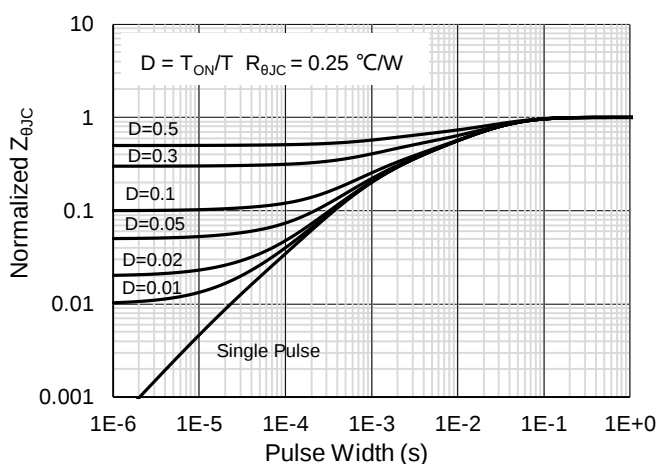


Figure 21: Normalized Maximum Transient Thermal Impedance

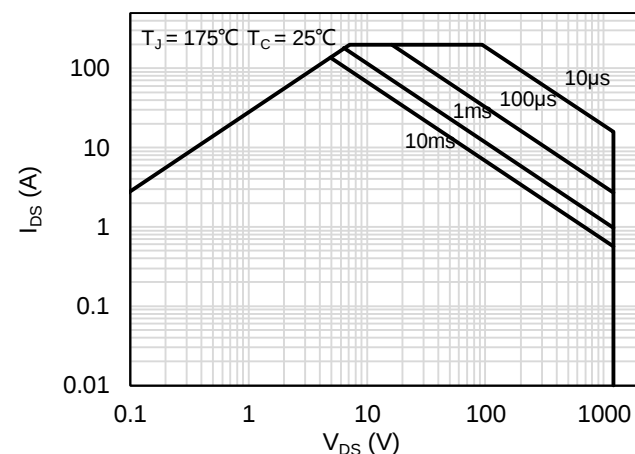


Figure 22: Maximum Forward Biased Safe Operating Area

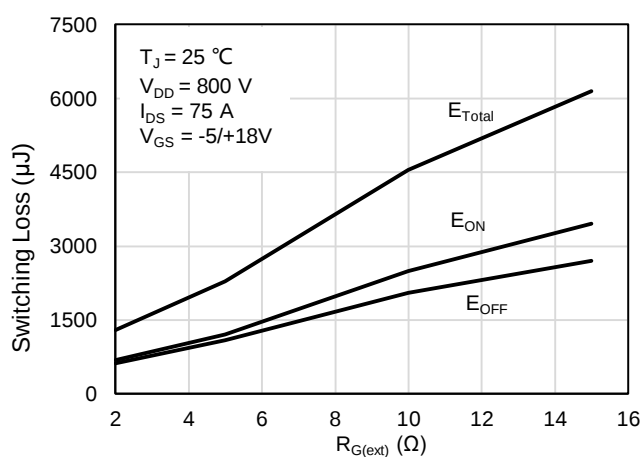
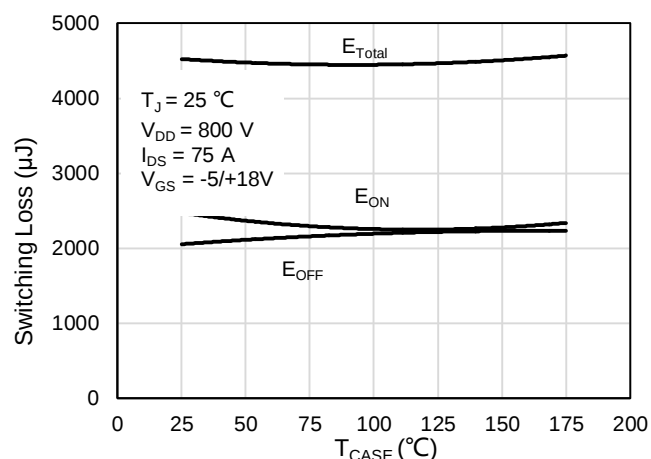
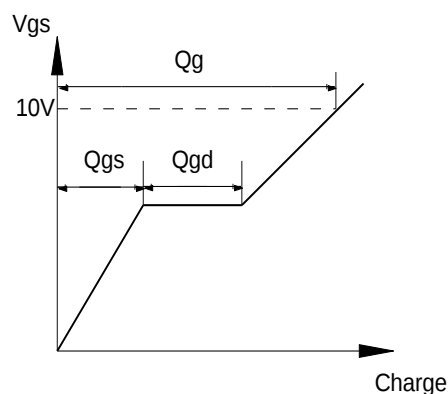
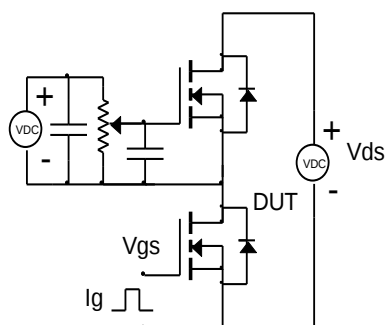
Figure 23: Clamped Inductive Switching Energy vs. $R_{G(ext)}$ 

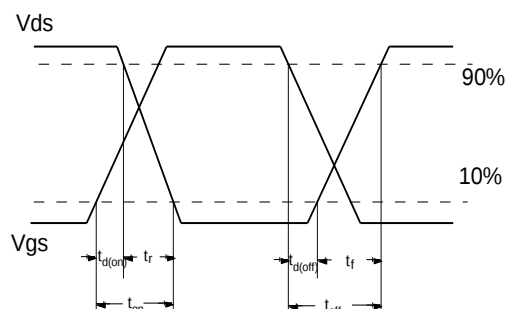
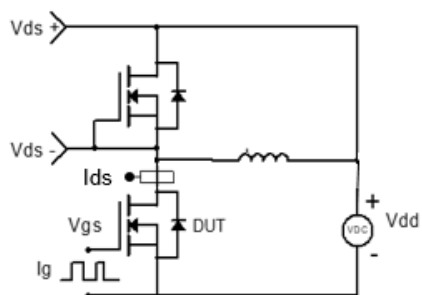
Figure 24: Clamped Inductive Switching Energy vs. Temperature

Test Circuit and Waveform

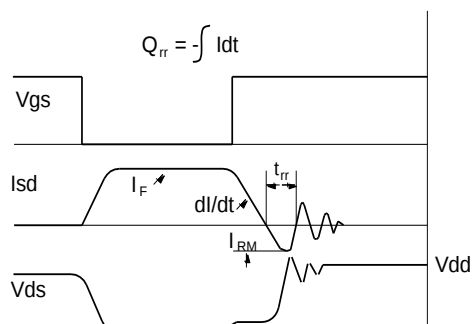
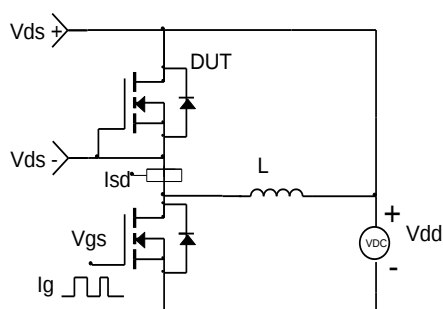
Gate Charge Test Circuit & Waveform



Clamped Inductive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Revision History

Revision	Release Date	Remark
Rev.1.0	2024/7/1	

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.